

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Reissue Application of:

Dennison et al.

U.S. Patent No.: 5,229,326

Issued: July 20, 1993

For: METHOD FOR MAKING ELECTRICAL CONTACT WITH AN ACTIVE AREA THROUGH SUB-MICRON CONTACT OPENINGS AND A SEMICONDUCTOR

DEVICE

Reissue Serial No.: 09/488,099

Filed: January 18, 2000

Examiner: K. Picardat

Group Art Unit: 2822

Attorney Docket No.: 3255.1US (91-507.1-

RE)

CERTIFICATE OF MAILING

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Joseph A. Walkowski
Typed/printed name of person whose signature is contained above

TECHNOLOGY CENTER 2800

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents Washington, D.C. 20231

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Information Disclosure Statement be entered and the documents listed on attached Form PTO-1449 or PTO/SB/08A be considered by the Examiner and made of record. Copies of the listed documents are enclosed pursuant to 37 C.F.R. § 1.98(a).

04/10/2002 BABRAHA1 00000038 09488099

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In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicants herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

DOCUMENTS

U.S. Patent Documents

U.S. Patent No.	Issue Date	<u>Inventor</u>
4,617,193	10/1986	Wu
4,714,686	12/1987	Sander et al.
4,868,138	09/1989	Chan et al.
4,892,845	01/1990	Bridges
5,110,766	05/1992	Maeda et al.
5,124,280	06/1992	Wei et al.
5,158,910	10/1992	Cooper et al.
5,171,713	12/1992	Matthews

Foreign Patent Documents

Document No.	<u>Date</u>	Country
41 07 883	09/1991	DE
62-32630	02/1987	JP
64-72543	03/1989	JP

Other Documents

Yoshire Nakata et al., "Tunnel Shape Stacked Capacitor (TSSC) Memory Cell for 64Mb Dram", article (date unknown).

Application Serial No. 09/488,099

Applicants offer to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

This Information Disclosure Statement is filed after the mailing date of the first Office Action on the merits. The fee pursuant to 37 C.F.R. § 1.17(p) is enclosed.

Respectfully submitted,

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Date: April 5, 2002

JAW/ps:dlm

Enclosures: Form PTO-1449 or PTO/SB/08A

Copy of documents cited

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(2-92)

Sheet 1 of 1

INFORMATION SURE CITATION

Docket Number (Optional)
3255.1US (91-507.1-RE)

Application Number
09/488,099

Applicant Dennison et al.

IN AN APPLICATION Filing Date January 18, 2000 Group Art Unit 2822 (Use several sheets if necessary) **U.S. PATENT DOCUMENTS EXAMINER** DOCUMENT FILING DATE DATE NAME CLASS SUBCLASS NUMBER IF APPROPRIATE INITIAL 4,617,193 10/1986 Wu 12/1987 4,714,686 Sander et al. 4,868,138 09/1989 Chan et al. 4,892,845 01/1990 **Bridges** 5,110,766 05/1992 Maeda et al. 5,124,280 06/1992 Wei et al. 5,158,910 10/1992 Cooper et al. CHNO 5,171,713 12/1992 Matthews 沼 <u>__</u> FOREIGN PATENT DOCUMENTS DOCUMENT NUMBER DATE SUBCLASS COUNTRY CLASS ÖES. NO 41 07 883 09/1991 DE Х 62-32630 02/1987 JΡ Х 64-72543 JΡ 03/1989 Х **OTHER DOCUMENTS** (Including Author, Title, Date, Pertinent Pages, Etc.) Yoshire Nakata et al., "Tunnel Shape Stacked Capacitor (TSSC) Memory Cell for 64Mb Dram", article (date unknown). **EXAMINER** DATE CONSIDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.